

# PF08103B

MOS FET Power Amplifier Module  
for E-GSM900 and DCS1800 Dual Band Handy Phone

## HITACHI

ADE-208-785D (Z)  
5th Edition  
Jan. 2001

### Application

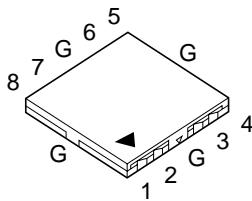
- Dual band amplifier for E-GSM900 (880 MHz to 915 MHz) and DCS1800 (1710 MHz to 1785 MHz).
- For 3.5 V nominal battery use

### Features

- 1 in / 2 out dual band amplifier
- Simple external circuit including output matching circuit
- Simple band switching and power control
- High gain 3stage amplifier : +1 dBm input for GSM, +4.5 dBm input for DCS
- Lead less thin & Small package :  $11 \times 13.75 \times 1.8$  mm
- High efficiency : 45 % Typ at 35.0 dBm for E-GSM  
35 % Typ at 32.5 dBm for DCS1800

### Pin Arrangement

• RF-O



1:  $\sqrt{V_{CTL}}$   
2:  $V_{CTL}$   
3: Vdd2  
4: Pout<sub>GSM</sub>  
5: Pout<sub>DCS</sub>  
6: Vdd1  
7: Vapc  
8: Pin  
G: GND

**Absolute Maximum Ratings** ( $T_c = 25^\circ\text{C}$ )

Item	Symbol	Rating	Unit
Supply voltage	$V_{DD}$	8.0	V
Supply current	$I_{DD\text{ GSM}}$	3.5	A
	$I_{DD\text{ DCS}}$	2	A
$V_{CTL}$ , $\overline{V_{CTL}}$ voltage	$V_{CTL}$ , $\overline{V_{CTL}}$	4	V
Vapc voltage	Vapc	4	V
Input power	Pin	10	dBm
Operating case temperature	$T_c$ (op)	-30 to +100	$^\circ\text{C}$
Storage temperature	Tstg	-30 to +100	$^\circ\text{C}$
Output power	$P_{out\text{ GSM}}$	5	W
	$P_{out\text{ DCS}}$	3	W

Note: The maximum ratings shall be valid over both the E-GSM-band (880 MHz - 915 MHz), and the DCS-band (1710 MHz - 1785 MHz).

**Electrical Characteristics for DC** ( $T_c = 25^\circ\text{C}$ )

Item	Symbol	Min	Typ	Max	Unit	Test Condition
Drain cutoff current	Ids	—	—	20	$\mu\text{A}$	$V_{DD} = 4.7\text{ V}$ , $V_{apc} = 0\text{ V}$ , $V_{CTL} = 0\text{ V}$ , $\overline{V_{CTL}} = 0\text{ V}$
		—	—	300	$\mu\text{A}$	$V_{DD} = 4.7\text{ V}$ , $V_{apc} = 0\text{ V}$ , $V_{CTL} = 0\text{ V}$ , $\overline{V_{CTL}} = 0\text{ V}$ , $T_c = -20\text{ to }+80^\circ\text{C}$
Vapc control current	Iapc	—	—	3	mA	$V_{apc} = 2.2\text{ V}$
$V_{CTL}$ control current	$I_{CTL}$	—	—	2	$\mu\text{A}$	$V_{CTL} = 3\text{ V}$
$\overline{V_{CTL}}$ control current	$\overline{I_{CTL}}$	—	—	1	$\mu\text{A}$	$\overline{V_{CTL}} = 3\text{ V}$

**Electrical Characteristics for GSM900 mode (T<sub>c</sub> = 25°C)**

Test conditions unless otherwise noted:

 $f = 880 \text{ to } 915\text{MHz}$ ,  $V_{DD1} = V_{DD2} = 3.5\text{V}$ ,  $P_{in} = +1\text{dBm}$ ,  $V_{CTL} = 2.0\text{V}$ ,  $\overline{V_{CTL}} = 0.1\text{V}$ ,  $R_g = R_l = 50\Omega$ ,

 $T_c = 25^\circ\text{C}$ , Pulse operation with pulse width 577  $\mu\text{s}$  and duty cycle 1:8 shall be used.

Item	Symbol	Min	Typ	Max	Unit	Test Condition
Frequency range	f	880	—	915	MHz	
Control voltage range	V <sub>apc</sub>	0.2	—	2.2	V	
Total efficiency	$\eta_T$	40	45	—	%	P <sub>out GSM</sub> = 35dBm,
2nd harmonic distortion	2nd H.D.	—	-45	-35	dBc	V <sub>apc</sub> = controlled
3rd harmonic distortion	3rd H.D.	—	-45	-35	dBc	
4th~8th harmonic distortion	4th~8th H.D.	—	—	-35	dBc	
Input VSWR	VSWR (in)	—	1.5	3.5	—	
Output power (1)	P <sub>out</sub> (1)	35.0	36.0	—	dBm	V <sub>apc</sub> = 2.2V
Output power (2)	P <sub>out</sub> (2)	33.5	34.2	—	dBm	V <sub>DD</sub> = 3.0V, V <sub>apc</sub> = 2.2V, T <sub>c</sub> = +85°C
Isolation	—	—	-45	-37	dBm	V <sub>apc</sub> = 0.2 V
Isolation at DCS RF-output when GSM is active	—	—	-30	-20	dBm	P <sub>out GSM</sub> = 35dBm (GSM mode) Measured at f = 1760 to 1830MHz, P <sub>in</sub> (GSM) = +1dBm
Switching time	t <sub>r</sub> , t <sub>f</sub>	—	1	2	$\mu\text{s}$	P <sub>out GSM</sub> = 0 to 35.0dBm
Stability	—	No parasitic oscillation All spurious < -36 dBm (Res BW = 3 MHz)			—	V <sub>DD</sub> = 3 to 5.1V, P <sub>out</sub> ≤ 35.0dBm, V <sub>apc GSM</sub> ≤ 2.2V GSM pulse. R <sub>g</sub> = 50Ω, T <sub>c</sub> = 25°C, Output VSWR = 6 : 1 All phases
Load VSWR tolerance	—	No degradation or Permanent degradation			—	V <sub>DD</sub> = 3 to 5.1V, P <sub>out GSM</sub> ≤ 35.0dBm, V <sub>apc GSM</sub> ≤ 2.2V GSM pulse. R <sub>g</sub> = 50Ω, t = 20sec., T <sub>c</sub> = 25°C, Output VSWR = 10 : 1 All phases
Noise power	P <sub>noise1</sub>	—	—	-80	dBm	f <sub>0</sub> = 915MHz, f <sub>rx</sub> = f <sub>0</sub> +10MHz P <sub>out GSM</sub> = 35dBm, RES BW = 100kHz
	P <sub>noise2</sub>	—	—	-84	dBm	f <sub>0</sub> = 915MHz, f <sub>rx</sub> = f <sub>0</sub> +20MHz P <sub>out GSM</sub> = 35dBm, RES BW = 100kHz
Slope P <sub>out</sub> /V <sub>apc</sub>	—	—	—	200	dB/V	P <sub>out GSM</sub> = 0 to 35dBm
Phase shift	—	—	—	20	deg/ dB	P <sub>out GSM</sub> = 34 to 35dBm
Total conversion gain1	—	—	—	-5	dB	f <sub>0</sub> = 915MHz, (P <sub>in</sub> = +1dBm) Other sig. = 895MHz (P <sub>in</sub> = -40dBc) P <sub>out GSM</sub> = 33.5dBm
Total conversion gain2	—	—	—	-5	dB	f <sub>0</sub> = 915MHz, (P <sub>in</sub> = +1dBm) Other sig. = 905MHz (P <sub>in</sub> = -40dBc) P <sub>out GSM</sub> = 33.5dBm
AM output	—	—	—	20	%	P <sub>out GSM</sub> = +5dBm, 4%AM modulation at input 50kHz modulation frequency

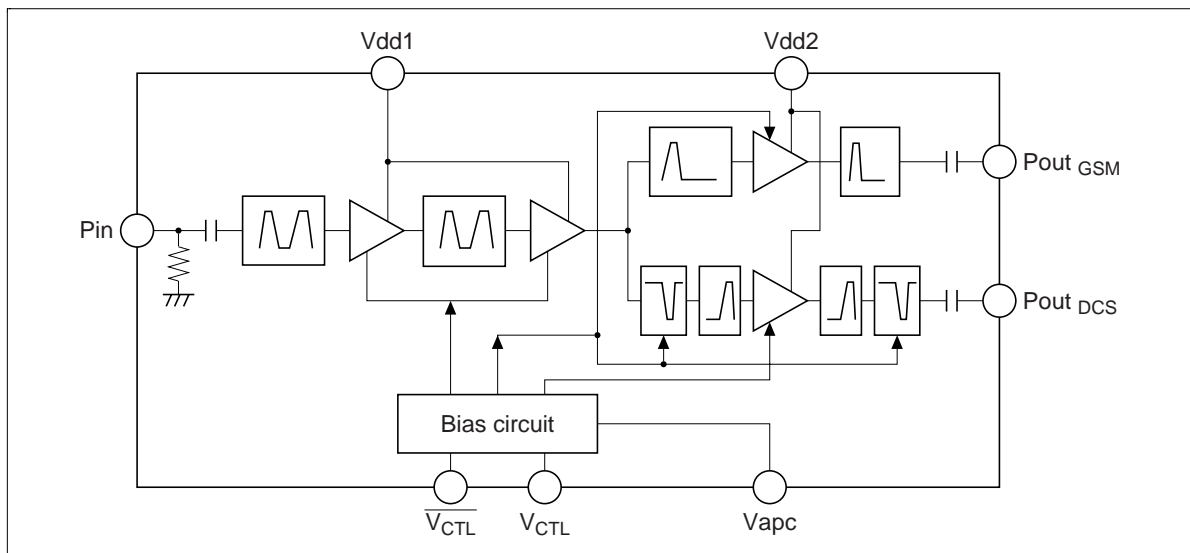
**Electrical Characteristics for DCS1800 mode (Tc = 25°C)**

Test conditions unless otherwise noted:

f = 1710 to 1785MHz, V<sub>DD1</sub> = V<sub>DD2</sub> = 3.5V, Pin = +4.5dBm, V<sub>CTL</sub> = 0.1V,  $\overline{V_{CTL}} = 2.0V$ , Rg = Rl = 50Ω, Tc = 25°C, Pulse operation with pulse width 577 μs and duty cycle 1:8 shall be used.

Item	Symbol	Min	Typ	Max	Unit	Test Condition
Frequency range	f	1710	—	1785	MHz	
Control voltage range	Vapc	0.2	—	2.2	V	
Total efficiency	η <sub>T</sub>	30	35	—	%	Pout <sub>DCS</sub> = 32.5dBm,
2nd harmonic distortion	2nd H.D.	—	-45	-35	dBc	Vapc = controlled
3rd harmonic distortion	3rd H.D.	—	-45	-35	dBc	
4th~8th harmonic distortion	4th~8th H.D.	—	—	-35	dBc	
Input VSWR	VSWR (in)	—	3	4	—	
Output power (1)	Pout (1)	32.5	33	—	dBm	Vapc = 2.2V
Output power (2)	Pout (2)	30.8	31.3	—	dBm	V <sub>DD</sub> = 3.1V, Vapc = 2.2V, Tc = +85°C
Isolation	—	—	-42	-37	dBm	Vapc = 0.2V
Switching time	t <sub>r</sub> , t <sub>f</sub>	—	1	2	μs	Pout <sub>DCS</sub> = 0 to 32.5dBm
Stability	—	No parasitic oscillation All spurious < -36 dBm (Res BW = 3 MHz)			—	V <sub>DD</sub> = 3.1 to 5.1V, Pout <sub>DCS</sub> ≤ 32.5dBm, Vapc ≤ 2.2V DCS pulse. Rg = 50Ω, Tc = 25°C, Output VSWR = 6 : 1 All phases
Load VSWR tolerance	—	No degradation or Permanent degradation			—	V <sub>DD</sub> = 3.1 to 5.1V, Pout <sub>DCS</sub> ≤ 32.5dBm, Vapc ≤ 2.2V DCS pulse. Rg = 50Ω, t = 20sec., Tc = 25°C, Output VSWR = 10 : 1 All phases
Noise power	Pnoise	—	—	-77	dBm	f <sub>0</sub> = 1785MHz, f <sub>rx</sub> = f <sub>0</sub> +20MHz, Pout <sub>DCS</sub> = 32.5dBm, RES BW = 100kHz
Slope Pout/Vapc	—	—	—	200	dB/V	Pout <sub>DCS</sub> = 0 to 32dBm
Phase shift	—	—	—	20	deg/ dB	Pout <sub>DCS</sub> = 31 to 32dBm
Total conversion gain	—	—	—	-5	dB	f <sub>0</sub> = 1785MHz, (Pin = +4.5dBm) Other sig. = 1765 MHz (-40dBc) Pout <sub>DCS</sub> = 31dBm
AM output	—	—	—	20	%	Pout <sub>DCS</sub> = 0dBm, 4%AM modulation at input 50kHz modulation frequency

**Internal Circuit Block Diagram**



**Band Select and Power Control**

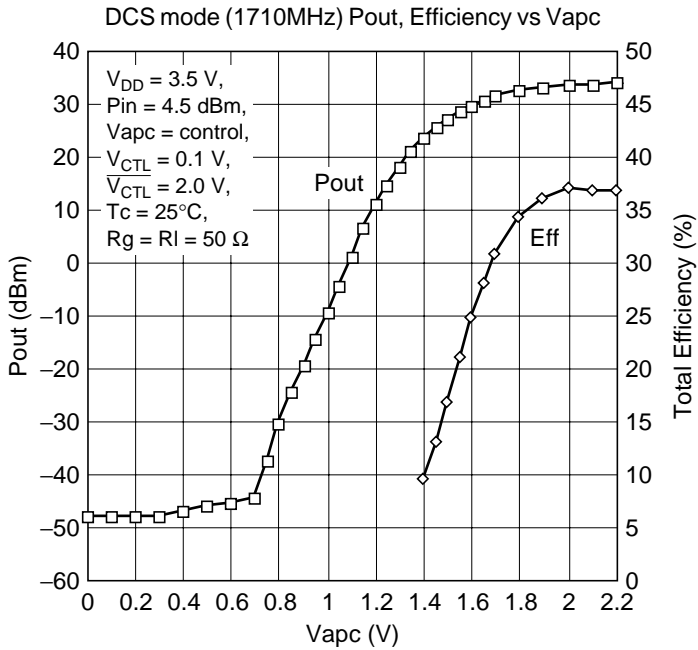
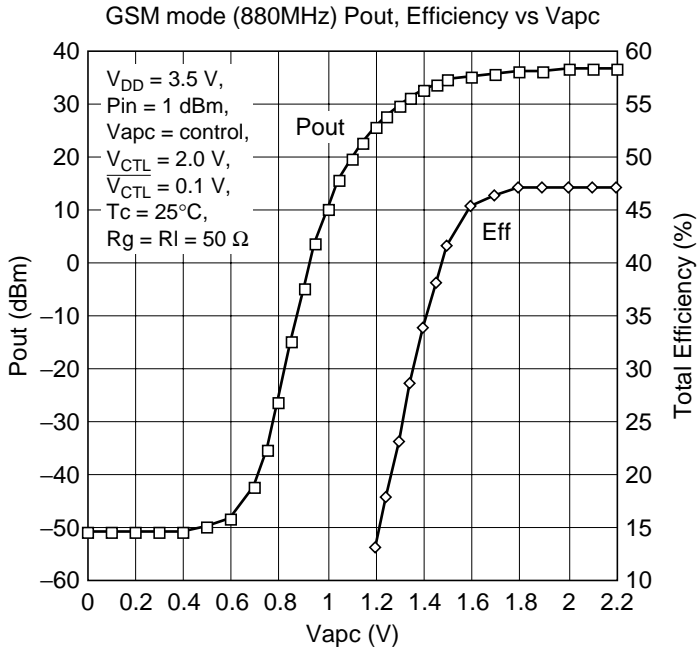
Operating Mode	V <sub>ctl</sub>	$\overline{V_{ctl}}$	V <sub>apc</sub>
GSM Tx ON	H	L	Control
DCS Tx ON	L	H	Control
Tx OFF	L	L	< 0.2 V

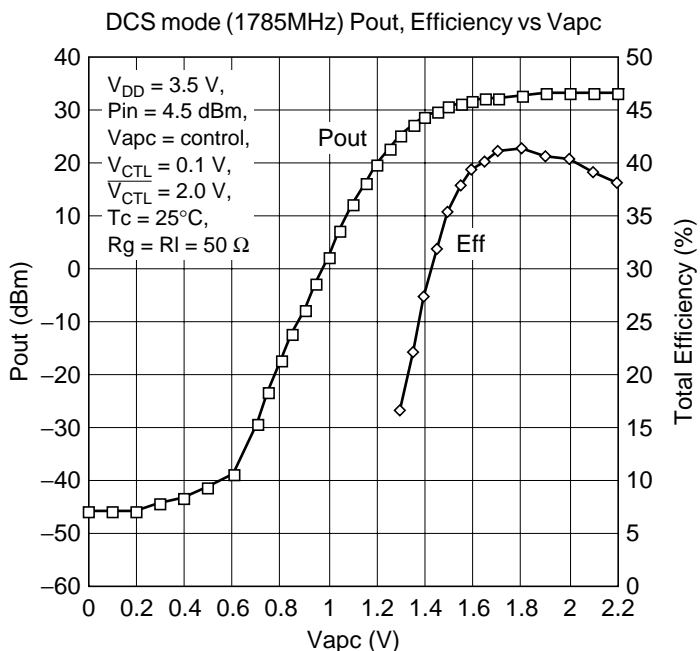
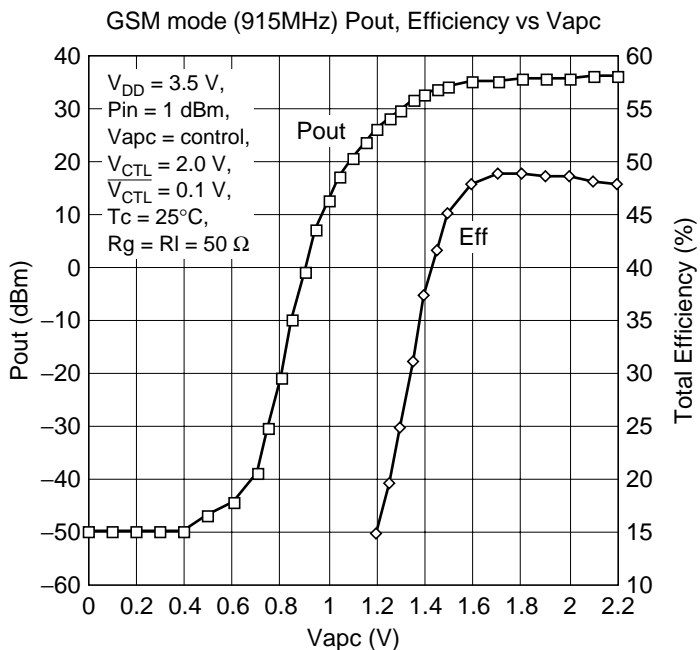
**Current of Control Pin**

Control Pin	Equivalent Input Circuit	Control Current
V <sub>ctl</sub>		2 μA Max
$\overline{V_{ctl}}$		1 μA Max
V <sub>apc</sub>		3 mA Max at 2.2 V

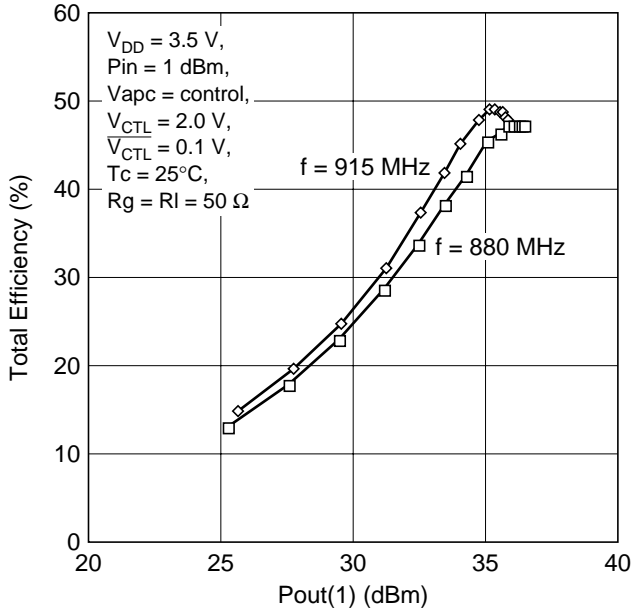
Note: Control current is preliminary value.

Characteristic Curves

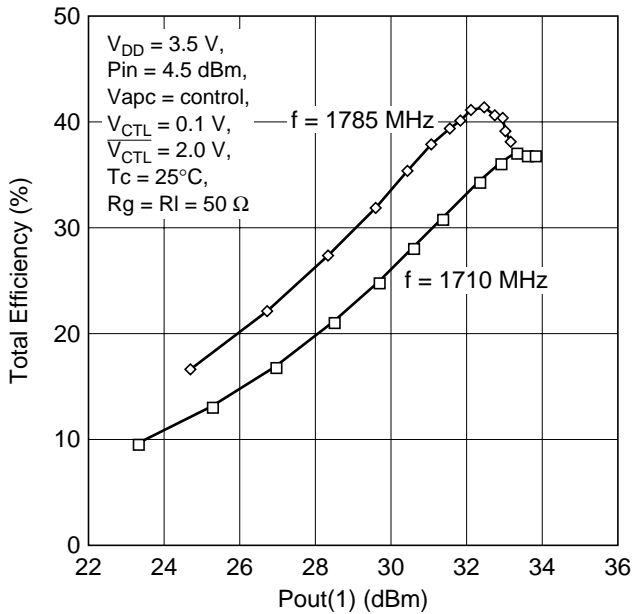




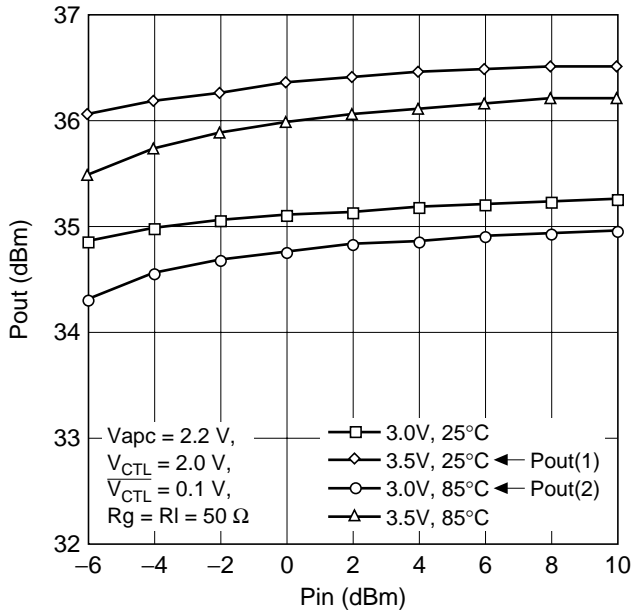
GSM mode Efficiency vs Pout(1)



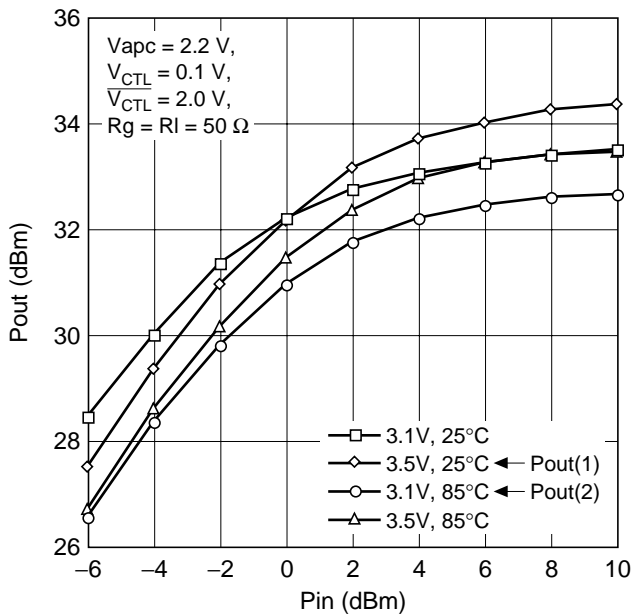
DCS mode Efficiency vs Pout(1)



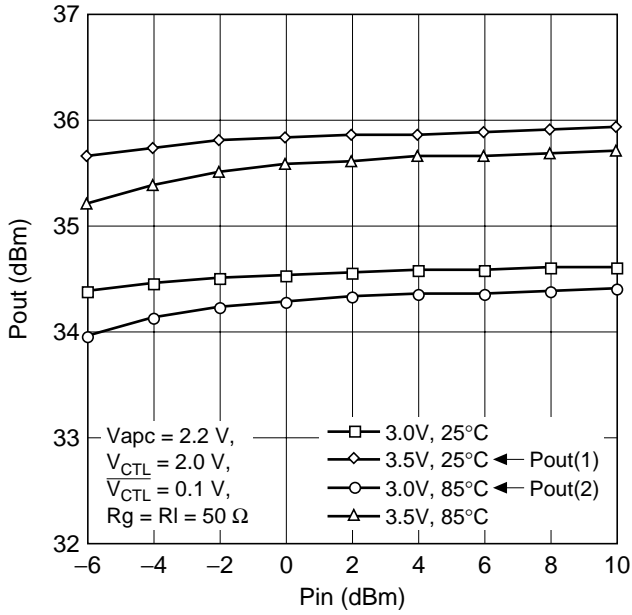
GSM mode (880MHz) Pout vs Pin



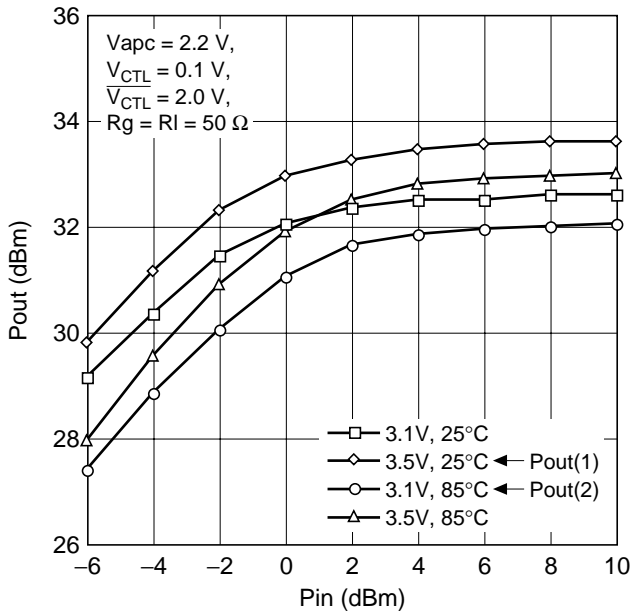
DCS mode (1710MHz) Pout vs Pin

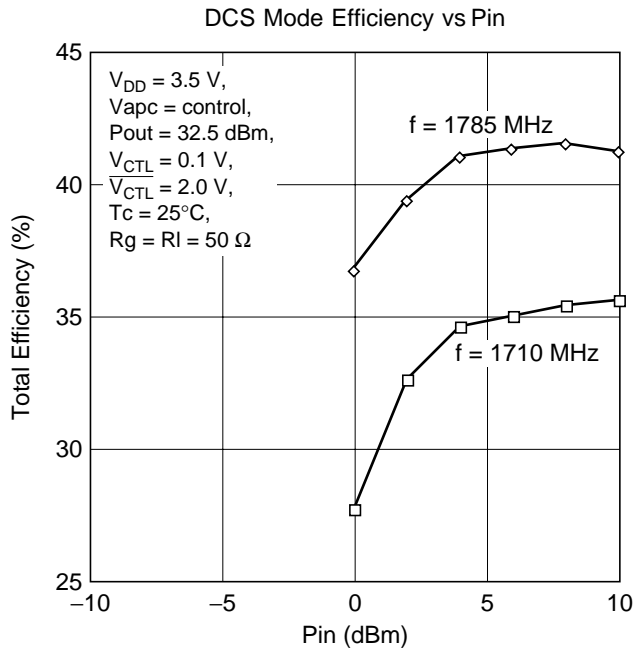
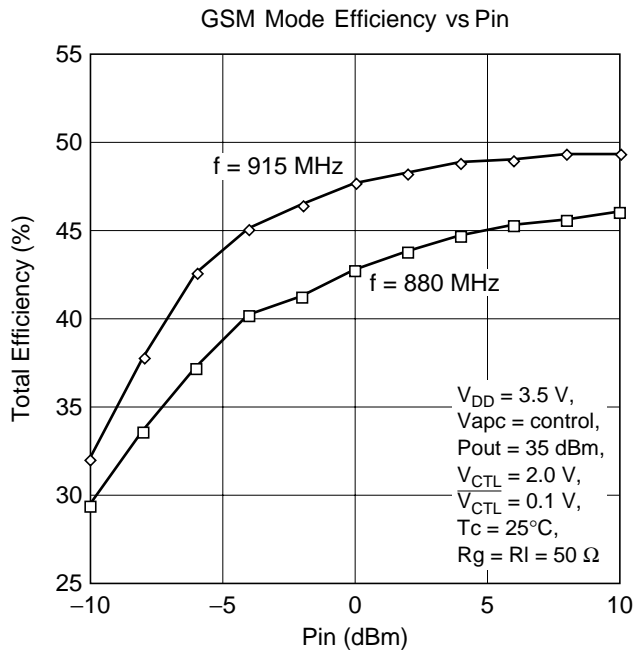


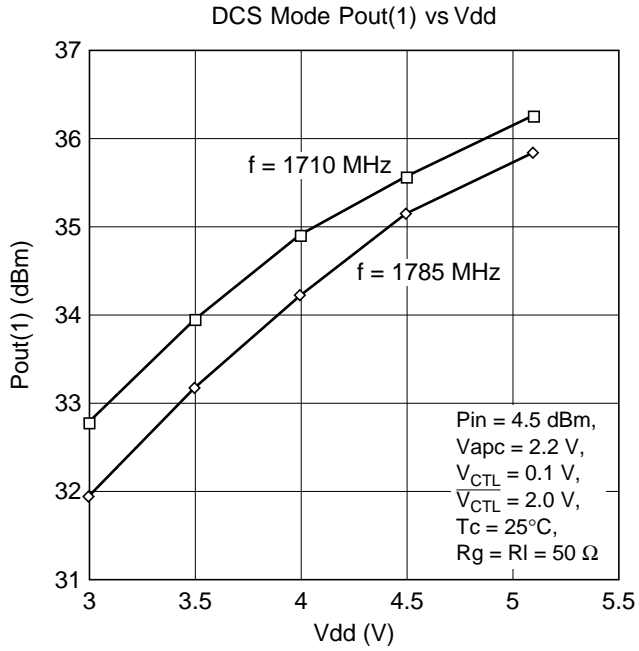
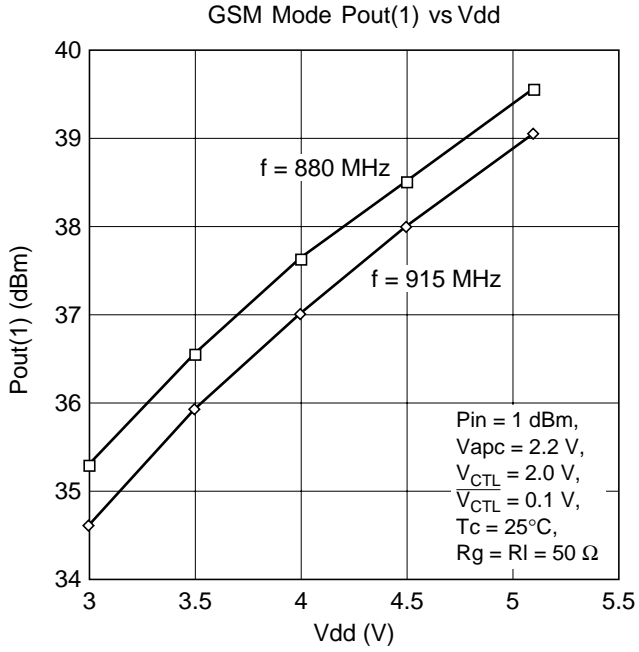
GSM mode (915MHz) Pout vs Pin



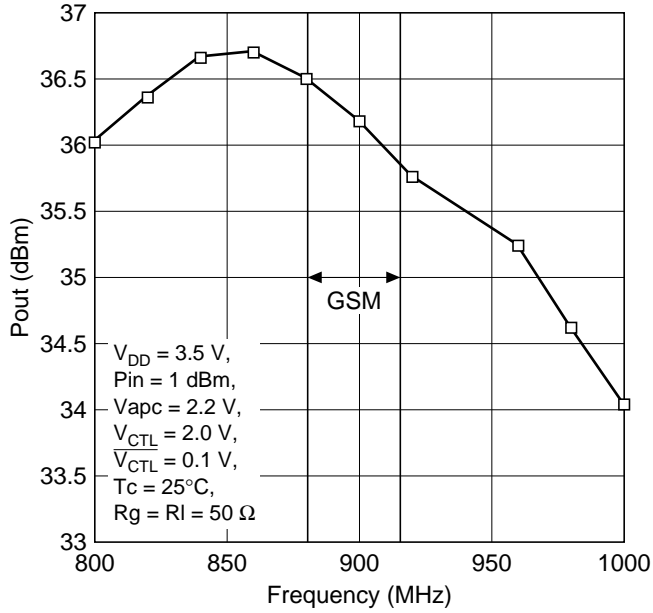
DCS mode (1785MHz) Pout vs Pin



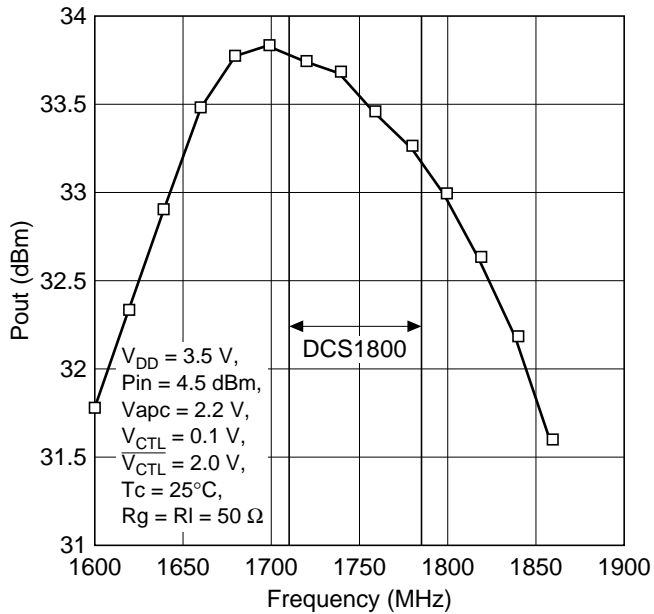




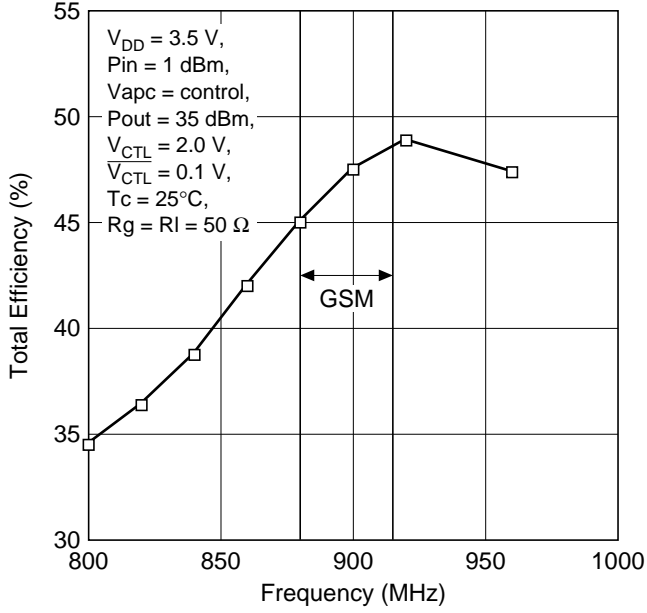
GSM Mode Pout(1) vs Frequency



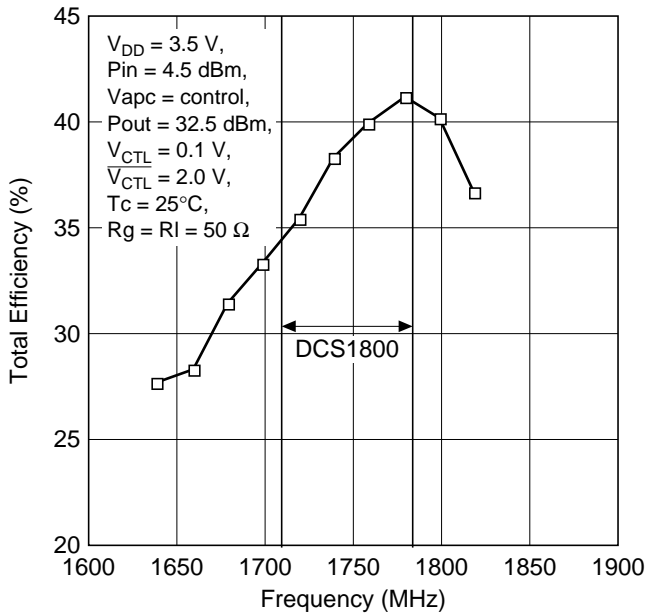
DCS Mode Pout(1) vs Frequency



GSM Mode Efficiency vs Frequency

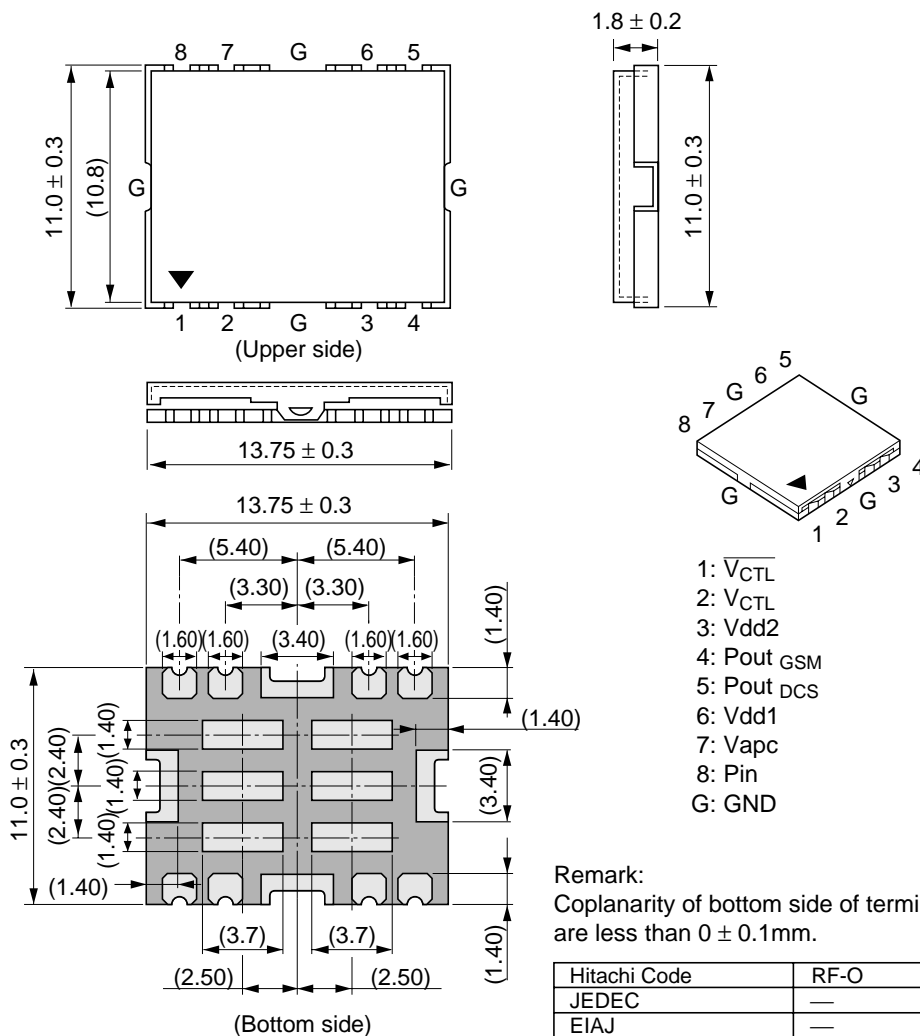


DCS Mode Efficiency vs Frequency



Package Dimensions

Unit: mm



Hitachi Code	RF-O
JEDEC	—
EIAJ	—
Mass (reference value)	—

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